

Data Sheet April 1995 File Number 3408.2

75A, 1200V Hyperfast Diode

The RHRU75120 (TA49042) is a hyperfast diode with soft recovery characteristics (t_{RR} < 85ns). It has half the recovery time of ultrafast diodes and is silicon nitride passivated ion-implanted epitaxial planar construction.

This device is intended for use as a freewheeling/clamping diode and rectifier in a variety of high frequency switching power supplies and other power switching applications. Its low stored charge and hyperfast soft recovery minimize ringing and electrical noise in many power switching circuits reducing power loss in the switching transistors.

Ordering Information

PACKAGING AVAILABILITY

PART NUMBER	PACKAGE	BRAND	
RHRU75120	TO-218	RHRU75120	

NOTE: When ordering, use the entire part number.

Features

•	Hyperfast with Soft Recovery <85ns
•	Operating Temperature +175°C
•	Reverse Voltage1200V

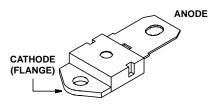
- · Avalanche Energy Rated
- Planar Construction

Applications

- Switching Power Supplies
- Power Switching Circuits
- General Purpose

Package

JEDEC STYLE TO-218



Symbol



Absolute Maximum Ratings $T_C = +25^{\circ}C$

	RHRU75120	UNITS
Peak Repetitive Reverse VoltageVRRM	1200	V
Working Peak Reverse Voltage	1200	V
DC Blocking Voltage	1200	V
Average Rectified Forward Current $I_{F(AV)}$ $(T_C = +46^{\circ}C)$	75	Α
Repetitive Peak Surge CurrentIFSM (Square Wave, 20kHz)	150	Α
Nonrepetitive Peak Surge Current	500	Α
Maximum Power Dissipation	190	W
Avalanche Energy	50	mj
Operating and Storage Temperature	-65 to +175	°C

Electrical Specifications $T_C = +25^{\circ}C$, Unless Otherwise Specified

			LIMITS			
SYMBOL	TEST CONDITION		MIN	TYP	MAX	UNITS
V _F	I _F = 75A		-	-	3.2	V
V _F	I _F = 75A	T _C = +150°C	-	-	2.6	V
I _R	V _R = 1200V		-	-	500	μΑ
I _R	V _R = 1200V	T _C = +150°C	-	-	2	mA
t _{RR}	I _F = 1A, dI _F /dt = 100A/μs		-	-	85	ns
t _{RR}	I _F = 75A, dI _F /dt = 100A/μs		-	-	100	ns
t _A	I _F = 75A, dI _F /dt = 100A/μs		-	60	-	ns
t _B	I _F = 75A, dI _F /dt = 100A/μs		-	25	-	ns
$R_{ heta JC}$			-	-	0.8	°C/W

DEFINITIONS

 V_F = Instantaneous forward voltage (pw = 300 μ s, D = 2%).

I_R = Instantaneous reverse current.

t_{RR} = Reverse recovery time (See Figure 2), summation of t_A + t_B.

t_A = Time to reach peak reverse current at (See Figure 2).

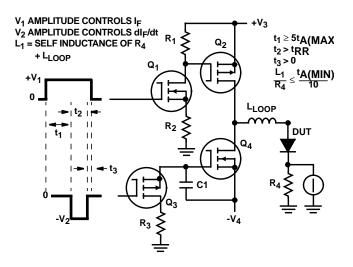
t_B = Time from peak I_{RM} to projected zero crossing of I_{RM} based on a straight line from peak I_{RM} through 25% of I_{RM} (See Figure 2).

 $R_{\theta JC}$ = Thermal resistance junction to case.

 E_{AVL} = Controlled avalanche energy (See Figures 7 and 8).

pw = pulse width.

D = duty cycle.





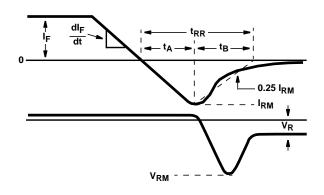


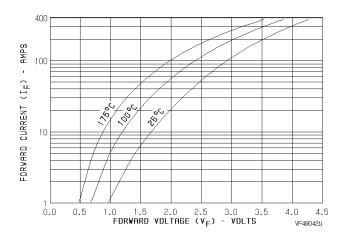
FIGURE 2. t_{RR} WAVEFORMS AND DEFINITIONS

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Typical Performance Curves



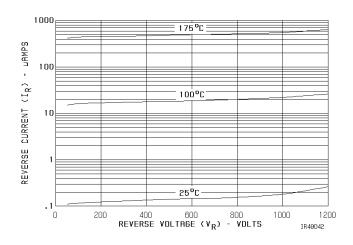


FIGURE 3. TYPICAL FORWARD CURRENT vs FORWARD VOLTAGE DROP

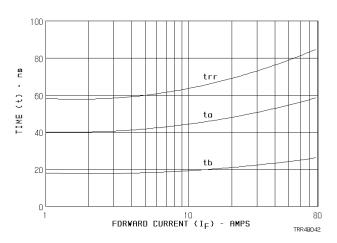


FIGURE 4. TYPICAL REVERSE CURRENT vs VOLTAGE

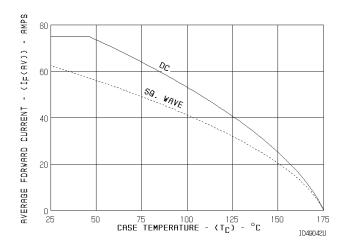


FIGURE 5. TYPICAL t_{RR} , t_{A} AND t_{B} CURVES vs FORWARD CURRENT

FIGURE 6. CURRENT DERATING CURVE FOR ALL TYPES

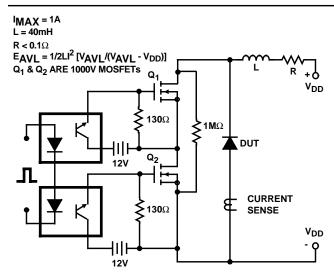


FIGURE 7. AVALANCHE ENERGY TEST CIRCUIT

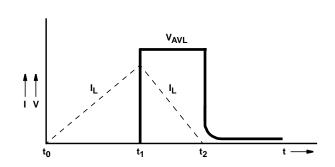


FIGURE 8. AVALANCHE CURRENT AND VOLTAGE WAVE-FORMS